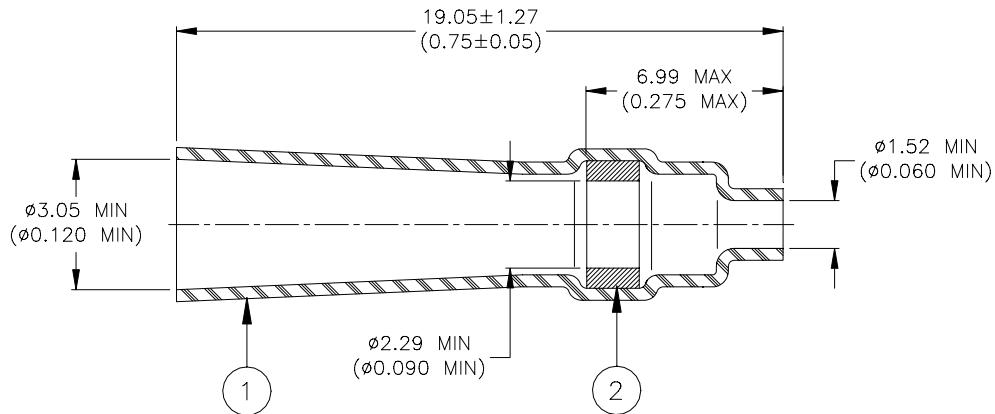


SPECIFICATION CONTROL DRAWING



MATERIALS

1. INSULATION SLEEVE: Heat shrinkable, transparent blue, radiation cross-linked modified polyvinylidene fluoride.
2. SOLDER PREFORM WITH FLUX:
 - SOLDER: TYPE Sn63 per ANSI J-STD-006.
 - FLUX: TYPE ROL1 per ANSI J-STD-004.

APPLICATION

1. This part is designed to attach a 20 or 22 AWG lead to a solder dipped pin 1.02 (0.040) in diameter.
2. Part may be installed with infrared or convection heating technique.

tyco <hr/> Electronics		Raychem	Tyco Electronics Corporation 300 Constitutional Drive Menlo Park, CA 94025 USA	TITLE : SOLDERSLEEVE, LEAD/ PIN TERMINATION			
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS. INCHES DIMENSIONS ARE BETWEEN BRACKETS.				DOCUMENT NO.: D-141-56			
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A	ANGLES: N/A ROUGHNESS IN MICRON	Tyco Electronics reserves the right to amend this drawing at any time. Users should evaluate the suitability of the product for their application.				DATE: 04-Apr.-01	DOC ISSUE: 1
DRAWN BY: M. FORONDA	CAGE CODE: 06090	REPLACES: N/A	DCR NUMBER: D010067	PROD. REV.:	A	SCALE: None	SIZE: A
SHEET: 1 of 1							

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